



SDM2A40CSP

2A SCHOTTKY BARRIER RECTIFIER CHIP SCALE PACKAGE

Product Summary

V _{RRM} (V)	I _O (A)	V _{F Max} (V)	I _{R Max} (μΑ)
40	2	0.58	100

Features and Benefits

- Low Forward Voltage (V_F) Minimizes Conduction Losses and Improves Efficiency
- Reduced High Temperature Reverse Leakage; Increased Reliability Against Thermal Runaway Failure in High-Temperature Operation
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Description and Applications

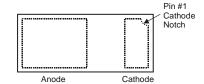
The SDM2A40CSP is a 40V 2A Schottky barrier rectifier optimized for low forward voltage drop and low leakage current housed in a compact chip scale package (CSP) that occupies only 1.28mm² board space with a low profile. The low thermal resistance enables designers to meet design challenges of increasing efficiency while at the same time reducing board space. It is ideally suited for use in portable applications as a:

- Blocking Diode
- Boost Diode
- Switching Diode
- Reverse Protection Diode

Mechanical Data

- Case: X3-WLB1608-2
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiAu Bump. Solderable per MIL-STD-202, Method 208 @4)
- Polarity: Cathode Dot
- Weight: 0.001 grams (Approximate)





Ordering Information (Note 4)

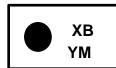
Part Number	Case	Packaging		
SDM2A40CSP-7B	X3-WLB1608-2	10,000/Tape & Reel		

Notes:

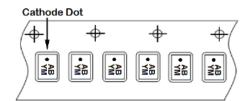
- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
- 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information





XB= Product Type Marking Code YM=Date Code Marking Y or \overline{Y} = Year (ex: F = 2018) M=Month (ex: 9= September) Dot Denotes Cathode Pin



Date Code Key

Year	201	8	2019		2020	20	21	2022		2023		2024
Code	F		G		Н			J		K		L
Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

Charac	teristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage		V_{RRM}	40	V
Average Rectified Output Current		lo	2	Α
Non-Repetitive Peak Forward Surg Single Half Sine-Wave Superimpos		I _{FSM}	28	А
Repetitive Peak Forward Current (Pulse Wave = 1 sec, Duty Cycle =	66%)	I _{FRM}	4	А
ESD Rating	Human Body Model Charged Device Model	ESD	8 1	KV

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Typical Thermal Resistance Junction to Ambient (Note 5)	R _{OJA}	137	°C/W
Total Power Dissipation (Note 5)	P _{TOT}	900	mW
Typical Thermal Resistance Junction to Ambient (Note 6)	R _Ð JA	50	°C/W
Total Power Dissipation (Note 6)	Ртот	2	W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150	°C

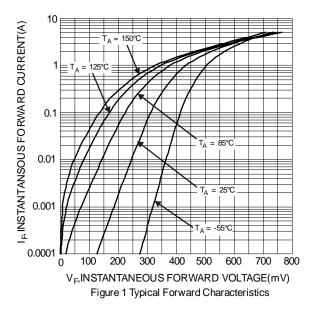
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

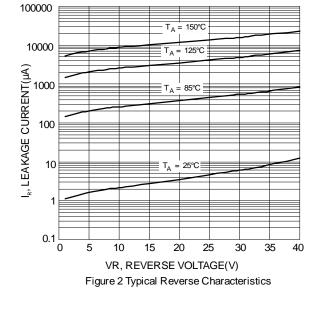
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Familiary National Duran	V _F		0.43	0.47	V	I _F = 1.0A, T _J = +25°C
Forward Voltage Drop		1	0.52	0.58	V	I _F = 2.0A, T _J = +25°C
Reverse Current (Note 7)	I _R		2 13 600	18 100 2000	μΑ	V _R = 10V, T _J = +25°C V _R = 40V, T _J = +25°C V _R = 32V, T _J = +85°C
Junction Capacitance	Ст	_	81	_	pF	V _R = 5V, f = 1.0MHz
Reverse Recovery Time	trr		14	_	ns	I _F =0.5A, I _R =1.0A, I _{rr} =0.25A

Notes:

- 5. Device mounted on FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html. 6. Device mounted on FR-4 PCB, 1 inch sq. copper pad, 2oz.
- 7. Short duration pulse test used to minimize self-heating effect.







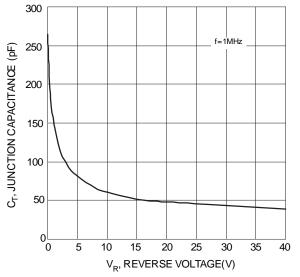


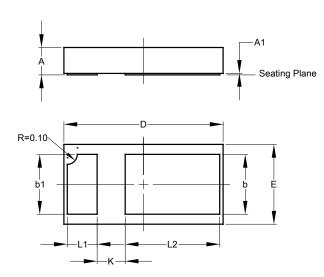
Figure 3 Typical Junction Capacitance



Package Outline Dimensions (Note 8)

Please see http://www.diodes.com/package-outlines.html for the latest version.

X3-WLB1608-2



X3-WLB1608-2							
Dim	Min	Max	Тур				
Α	0.250	0.300	0.275				
A1	_	0.015	_				
b		_	0.600				
b1		_	0.600				
D	1.57	1.63	1.60				
Е	0.77	0.83	0.80				
K	_	_	0.282				
L1	0.25	0.35	0.30				
L2	0.90	1.00	0.95				
All I	All Dimensions in mm						

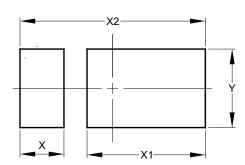
Note:

8. Device side walls are electrically active bare silicon. Avoid contact of solder or flux on the side walls during the PCB assembly process.

Suggested Pad Layout

 $\label{lem:please} Please see \ http://www.diodes.com/package-outlines.html \ for \ the \ latest \ version.$

X3-WLB1608-2



Dimensions	Value		
Dimensions	(in mm)		
Х	0.385		
X1	1.035		
X2	1.622		
Υ	0.690		



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